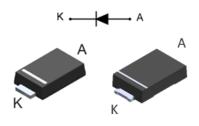
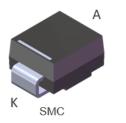


# 40 V, 3 A low drop Schottky rectifier







#### **Features**

- · Negligible switching losses
- Low forward voltage drop
- · Low thermal resistance
- Avalanche rated
- ECOPACK2 component

#### **Applications**

- Telecom power supply
- Set-top box power supply
- TV power supply
- · Battery charger

#### **Description**

Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SMB Flat Notch, SMB Flat and SMC, the STPS3L40 is ideal for surface mounting and used in DC/DC chargers.

Product status
STPS3L40

Product summary				
Symbol Value				
I <sub>F(AV)</sub>	3 A			
$V_{RRM}$	40 V			
T <sub>j(max.)</sub>	150 °C			
$V_{F(typ.)}$	0.40 V			



### 1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage				V
1	Average forward current, $\delta$ = 0.5, square	SMB Flat, SMB Flat Notch	T <sub>L</sub> = 120 °C	2	٨
IF(AV)	Wave wave	SMC	T <sub>L</sub> = 115 °C	- 3	A
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$				Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p$ = 10 $\mu$ s, $T_j$ = 125 $^{\circ}$ C				W
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C		
Tj	Maximum operating junction temperature <sup>(1)</sup>				°C

<sup>1.</sup>  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameter

Symbol	Parameter	Max. value	Unit	
D., ., .,	Junction to lead	SMB Flat, SMB Flat Notch	15	°C/W
R <sub>th(j-l)</sub>	Junction to lead	SMC	18	C/VV

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

**Table 3. Static electrical characteristics** 

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	Payaraa laakaga aurrant	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		100	μA
IR <sup>(*)</sup>	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 125 °C		-	16	40	mA
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 3 A	-		0.50	
V <sub>F</sub> <sup>(1)</sup>	Forward voltage drop	T <sub>j</sub> = 125 °C		-	0.40	0.44	V
VF	V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 6 A	-		0.62	V
		T <sub>j</sub> = 125 °C	1F - 0 A	-	0.52	0.58	

<sup>1.</sup> Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 

To evaluate the conduction losses, use the following equation:

$$P = 0.30 \times I_{F(AV)} + 0.047 \times I_{F}^{2}_{(RMS)}$$

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

DS1947 - Rev 5 page 2/13



#### 1.1 **Characteristics (curves)**

average forward current  $P_{F(AV)}(W)$ 2.0 δ = 0.2  $\delta = 0.1$  $\delta = 0.5$  $\delta = 0.05$ 1.6 δ = 1

Figure 1. Average forward power dissipation versus

1.2 0.8 0.4  $I_{F(AV)}(A)$  $\delta$ =tp/T 0.0 0.0 1.0 1.5 2.0 3.0 3.5 4.0

Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ ) (SMC)  $I_{F(AV)}(A)$ 3.5

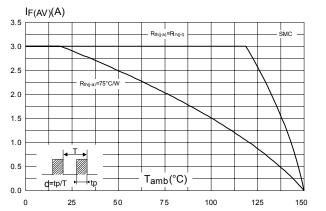


Figure 3. Average forward current versus ambient temperature ( $\delta$  = 0.5, SMB Flat)

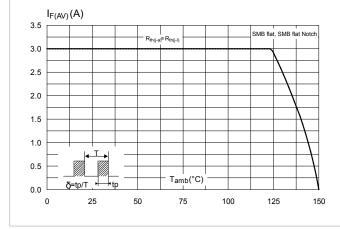


Figure 4. Normalized avalanche power derating versus pulse duration (T<sub>i</sub> = 125 °C)

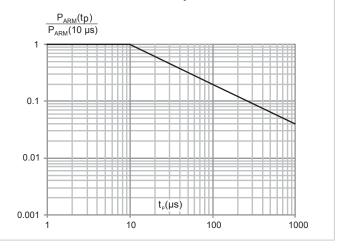


Figure 5. Relative variation of thermal impedance junction to ambient versus pulse duration (SMC)

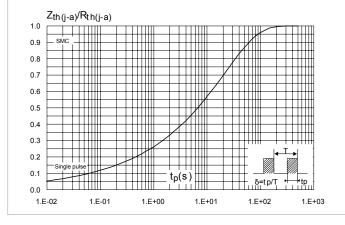
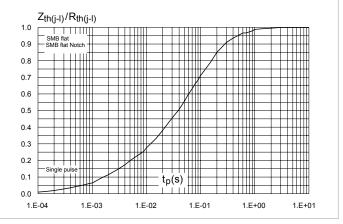


Figure 6. Relative variation of thermal impedance junction to lead versus pulse duration (SMB flat, SMB flat Notch)



DS1947 - Rev 5 page 3/13



0

5

10

15

20

25

30

IR(mA)

1.E+01

1.E-01

1.E-02

1.E-03

C(pF)

C(pF)

VR(V)

100

1 100

100

Figure 9. Forward voltage drop versus forward current I<sub>FM</sub>(A) 100.00 10.00 1.00 0.10 V<sub>FM</sub> (V) 0.01 0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7

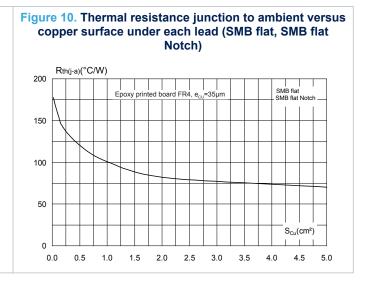
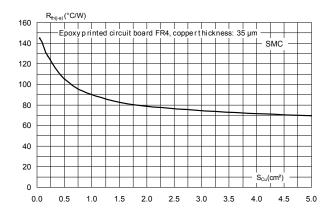


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead (SMC)

40

35



DS1947 - Rev 5 page 4/13



# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

### 2.1 SMB Flat package information

- Epoxy meets UL94, V0
- · Lead-free package

Figure 12. SMB Flat package outline

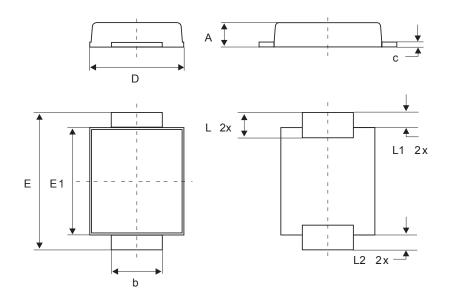


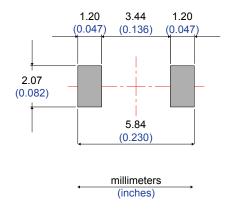
Table 4. SMB Flat mechanical data

			Di	mensions		
Ref.	Millimeters					
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.90		1.10	0.035		0.044
b	1.95		2.20	0.076		0.087
С	0.15		0.40	0.005		0.016
D	3.30		3.95	0.129		0.156
E	5.10		5.60	0.200		0.221
E1	4.05		4.60	0.159		0.182
L	0.75		1.50	0.029		0.060
L1		0.40			0.016	
L2		0.60			0.024	

DS1947 - Rev 5 page 5/13



Figure 13. Footprint recommendations, dimensions in mm (inches)



DS1947 - Rev 5 page 6/13



## 2.2 SMB Flat Notch package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 14. SMB Flat Notch package outline

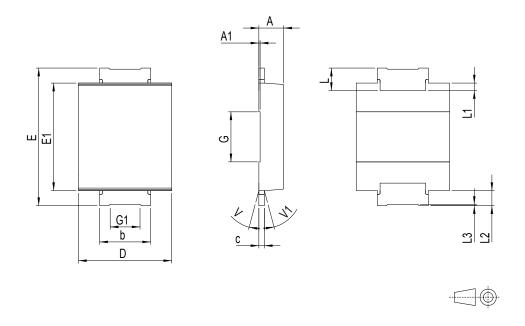


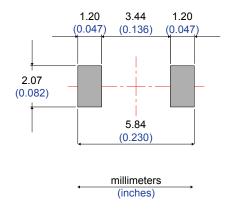
Table 5. SMB Flat Notch mechanical data

			Di	imensions			
Ref.	Millimeters		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.90		1.10	0.035		0.043	
A1		0.05			0.002		
b	1.95		2.20	0.077		0.087	
С	0.15		0.40	0.006		0.016	
D	3.30		3.95	0.130		0.156	
Е	5.20		5.60	0.205		0.220	
E1	4.05		4.60	0.159		0.181	
G		2.00			0.079		
G1		1.20			0.047		
L	0.75		1.20	0.030		0.047	
L1		0.30			0.012		
L2		0.60			0.024		
L3	0.02			0.001			
V			8°			8°	
V1			8°			8°	

DS1947 - Rev 5 page 7/13



Figure 15. Footprint recommendations, dimensions in mm (inches)



DS1947 - Rev 5 page 8/13



# 2.3 SMC package information

• Epoxy meets UL94, V0

Figure 16. SMC package outline

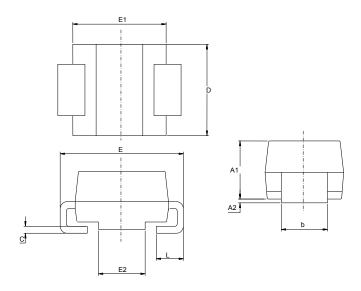


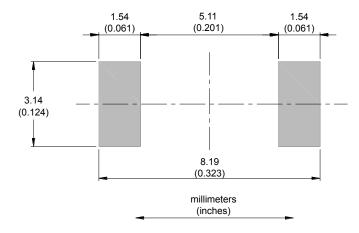
Table 6. SMC package mechanical data

	Dimensions						
Ref.	Millin	neters	Inches (for reference only)				
	Min.	Max.	Min.	Max.			
A1	1.90	2.45	0.0748	0.0965			
A2	0.05	0.20	0.0020	0.0079			
b	2.90	3.20	0.1142	0.1260			
С	0.15	0.40	0.0059	0.0157			
D	5.55	6.25	0.2185	0.2461			
E	7.75	8.15	0.3051	0.3209			
E1	6.60	7.15	0.2598	0.2815			
E2	4.40	4.70	0.1732	0.1850			
L	0.75	1.50	0.0295	0.0591			

DS1947 - Rev 5 page 9/13



Figure 17. SMC recommended footprint



DS1947 - Rev 5 page 10/13





# **3** Ordering information

**Table 7. Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS3L40UFN	B34	SMB Flat Notch	0.056 g	5 000	Tape and reel
STPS3L40UF	FS3L4	SMB Flat	0.050 g	5000	Tape and reel
STPS3L40S	S3L4	SMC	0.243 g	10 000	Tape and reel

DS1947 - Rev 5 page 11/13



# **Revision history**

**Table 8. Document revision history** 

Date	Version	Changes
Jul-2003	2A	Last update.
08-Feb-2007	3	Reformatted to current standard. Added ECOPACK statement. Added SMBflat package.
20-May-2013	4	Updated SMC package information. Updated ECOPACK statement. Corrected Y axis labels of Figure 12.
31-Jan-2020	5	Added Section 2.2 SMB Flat Notch package information.

DS1947 - Rev 5 page 12/13



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DS1947 - Rev 5 page 13/13

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